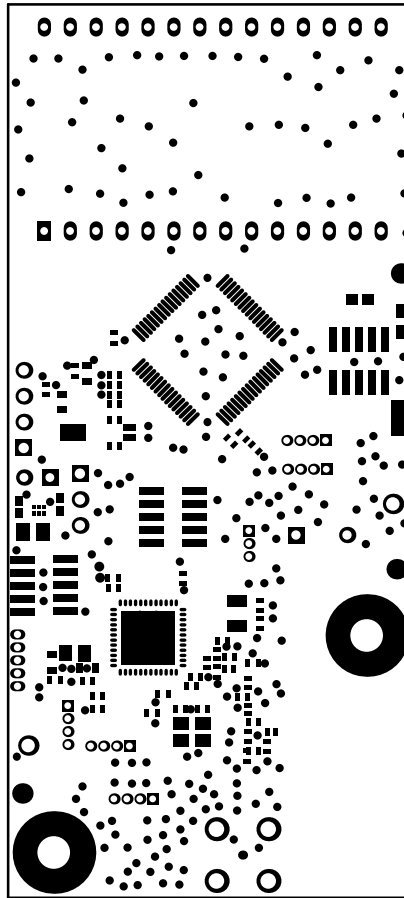
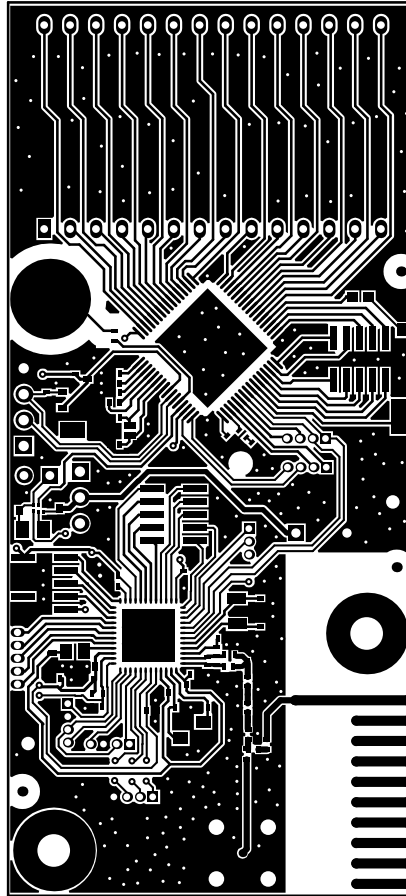


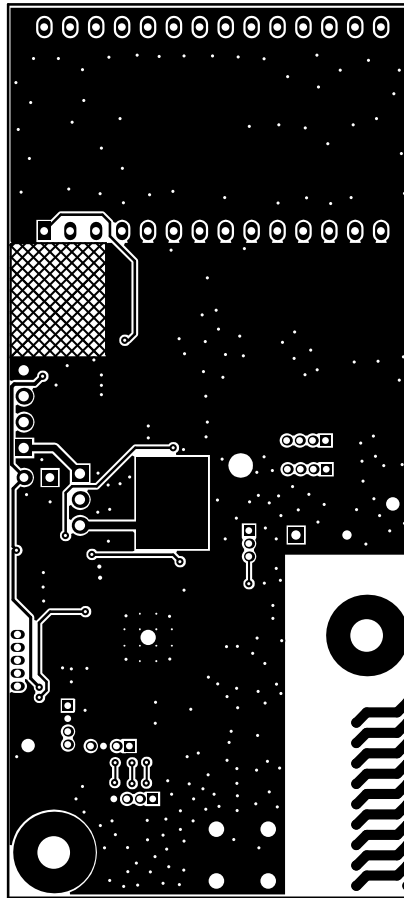
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00838	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Top Overlay	TID #: TIDA-00838		
PLOT NAME = Top Overlay	GENERATED : 11/17/2015 1:30:31 PM	TEXAS INSTRUMENTS	



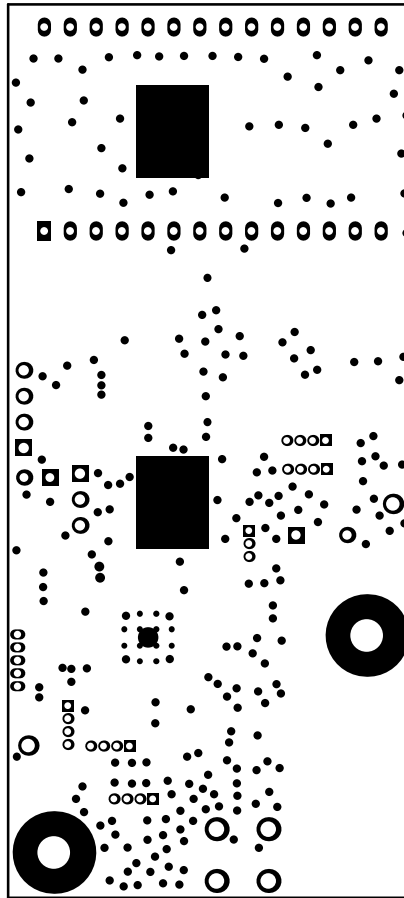
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00838	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Top Solder	TID #: TIDA-00838		
PLOT NAME = Top Solder Mask	GENERATED : 11/17/2015 1:30:35 PM	TEXAS INSTRUMENTS	



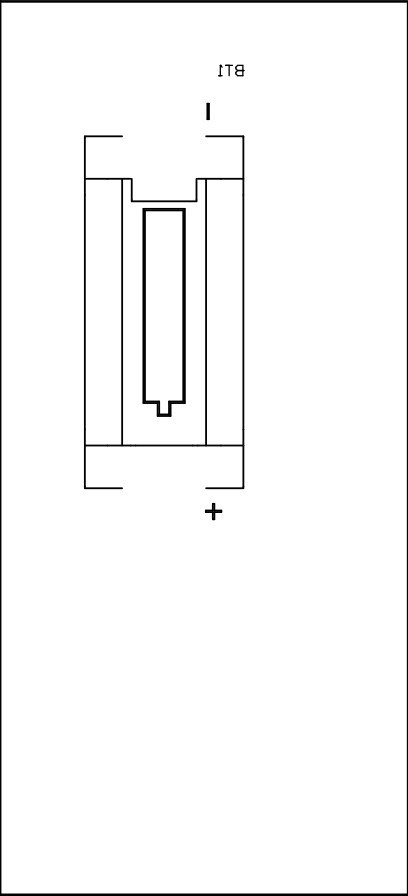
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00838	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Top Layer	TID #: TIDA-00838		
PLOT NAME = Top Layer	GENERATED : 11/17/2015 1:30:38 PM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00838	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Bottom Layer	TID #: TIDA-00838		
PLOT NAME = Bottom Layer	GENERATED : 11/17/2015 1:30:42 PM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00838	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Bottom Solder	TID #: TIDA-00838		
PLOT NAME = Bottom Solder Mask	GENERATED : 11/17/2015 1:30:46 PM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE

BOARD #: TIDA-00838

REV: E1

SUN REV: Not In VersionControl

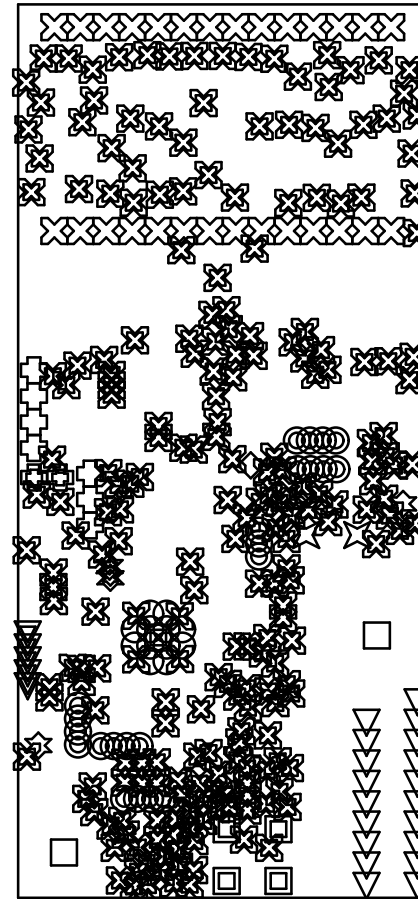
LAYER NAME = Bottom Overlay

TID #: TIDA-00838

PLOT NAME = Bottom Overlay

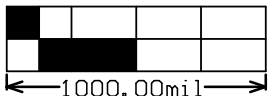
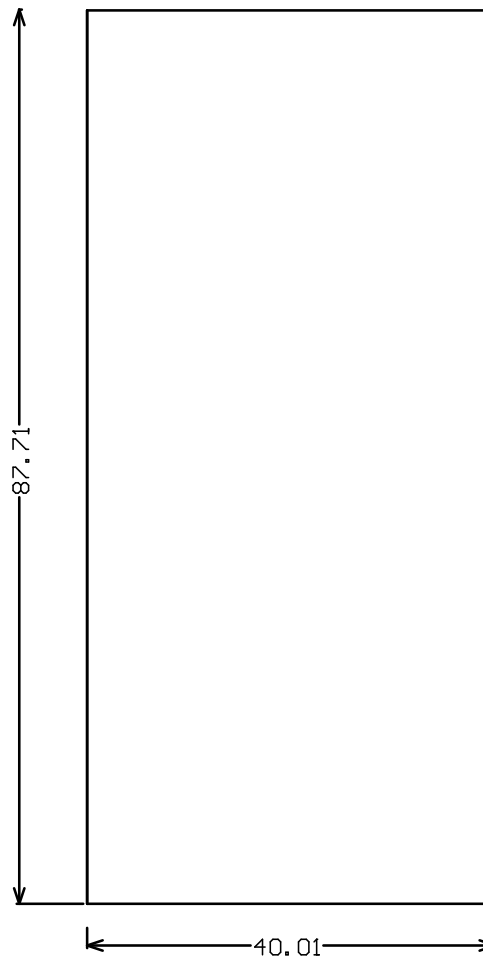
GENERATED : 11/17/2015 1:30:49 PM

TEXAS INSTRUMENTS



Symbol	Quantity	Finished Hole Size	Plated	Hole Type
◇	1	78.50mil (1.994mm)	NPTH	Round
○	12	7.87mil (0.200mm)	PTH	Round
✕	238	12.00mil (0.305mm)	PTH	Round
▽	19	14.96mil (0.380mm)	PTH	Round
✱	2	16.00mil (0.406mm)	PTH	Round
⊙	23	25.59mil (0.650mm)	PTH	Round
▽	5	27.56mil (0.700mm)	PTH	Round
⊗	28	29.53mil (0.750mm)	PTH	Round
⊕	2	33.46mil (0.850mm)	PTH	Round
⊗	2	35.43mil (0.900mm)	PTH	Round
⊕	7	40.00mil (1.016mm)	PTH	Round
✱	2	52.00mil (1.321mm)	PTH	Round
■	5	59.06mil (1.500mm)	PTH	Round
□	2	125.98mil (3.200mm)	PTH	Round
	348 Total			

ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00838	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Drill Drawing	TID #: TIDA-00838		
PLOT NAME = Drill Drawing	GENERATED : 11/17/2015 1:30:53 PM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00838	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = M2 Board Dimensions	TID #: TIDA-00838		
PLOT NAME = Board Dimensions	GENERATED : 11/17/2015 1:30:56 PM		TEXAS INSTRUMENTS

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